

Frame Grabber and Simulator Hardware Reference & Installation Guide

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2 Revision history

| Version | Date | Notes |
|---------|------------|---|
| 1.0 | 07.05.2020 | Initial release |
| 1.1 | 06.07.2022 | Updates to Figure 9, Figure 8, Figure 7, Table 15, Table 16 |

Table 1 – Revision History

Introduction

2.1 Safety precautions

With your card in hand, please take the time to read through the precautions listed below to prevent preventable and unnecessary injuries and damage to you, other personnel, or property. Read these safety instructions carefully before your first use of the product, as these precautions contain safety instructions that must be observed. Be sure to follow this manual to prevent misuse of the product.

| |
|---|
|  Caution! Read Carefully and do not disregard these instructions. |
| In the event of a failure, disconnect the power supply. Disconnect the power supply immediately and contact our sales personnel for repair. Continuing to use the product in this state may result in a fire or electric shock. |
| If an unpleasant smell or smoking occurs, disconnect the power supply. Disconnect the power supply immediately! Continuing to use the product in this state may result in a fire or electric shock. After verifying that no smoking is observed, contact our sales personnel for repair. |
| Do not disassemble, repair or modify the product. This may result in a fire or electric shock due to a circuit shortage or heat generation. Contact our sales personnel before inspection, modification, or repair. |
| Do not place the product on unstable surfaces. Otherwise, it may drop or fall, resulting in injury to persons or the camera. |
| Do not use the product if dropped or damaged. Otherwise, a fire or electric shock may occur. |
| Do not touch the product with metallic objects. Otherwise, a fire or electric shock may occur. |
| Do not place the product in dusty or humid environments, nor where water may splash. Otherwise, a fire or electric shock may occur. |
| Do not wet the product or touch it with wet hands. Otherwise, the product may fail or it may cause a fire, smoking, or electric shock. |
| Do not touch the gold-plated sections of the connectors on the product. Otherwise, the surface of the connector may be contaminated by sweat or skin oil, resulting in contact failure of a connector, malfunction, fire or electric shock due to static electricity discharge. |
| Do not use or place the product in the following locations. <ul style="list-style-type: none">▪ Unventilated areas such as closets or bookshelves.▪ Near oils, smoke or steam.▪ Next to heat sources.▪ A closed (and not running) car where the temperature becomes high.▪ Static electricity replete locations▪ Near water or chemicals. Otherwise, a fire, electric shock, accident or deformation may occur due to a short circuit or heat generation. |
| Do not place heavy objects on the product. Otherwise, the product may be damaged. |
| Be sure to discharge static electricity from the body before touching any sensitive electronic components. The electronic circuits in your computer and the circuits on the <i>Iron</i> camera and the <i>Predator II</i> board are sensitive to static electricity and surges. Improper handling may seriously damage the circuits. In addition, do not let your clothing come in contact with the circuit boards or components. Otherwise, the product may be damaged. |

2.2 Disclaimer

KAYA Instruments will assume no responsibility for any damage that may ensue by the use of this product for any purpose other than intended, as previously stated. Without detracting from what was previously written, please be advised that the company will take no responsibility for any damages caused by:

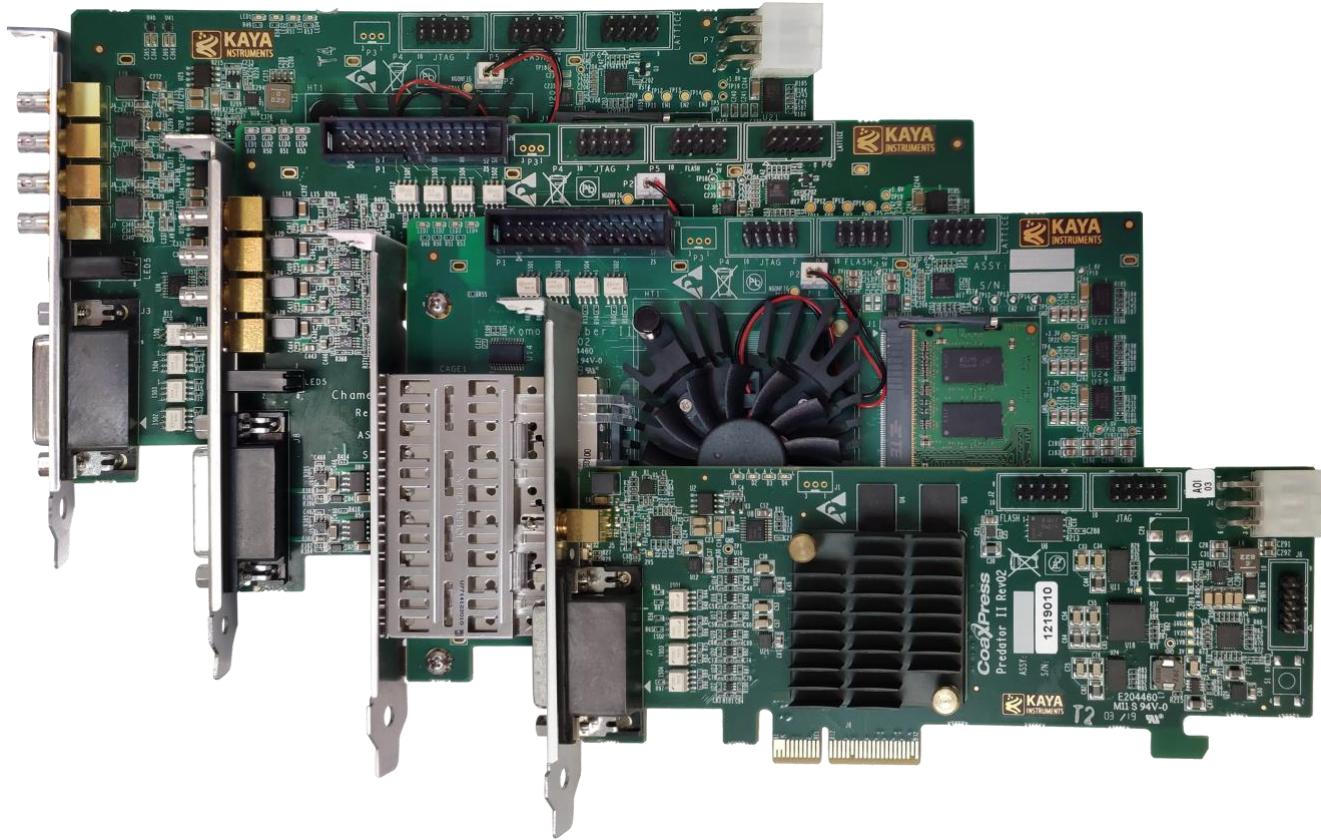
- Earthquake, thunderstrike, natural disasters, a fire caused by use beyond our control, willful and/or accidental misuse and/or use under other abnormal and/or unreasonable conditions.
- Secondary damages caused by the use of this product or its unusable state (business interruption or others).
- Use of this product in any manner that contradicts this manual or malfunctions that may occur due to connection to other devices. Damage to this product that is out of our control or failure due to modification
- Accidents and/or third parties that may be involved.

Additionally, **KAYA Instruments** assumes no responsibility or liability for:

- Erasure or corruption of data caused by the use of this product.
- Any consequences or other abnormalities following the use of this product

Repairs to this product are carried out by replacing it on a chargeable basis and not by repairing the faulty device. Non-chargeable replacement is offered for the initial failure, as long as it is reported no later than two weeks post delivery of the product.

3 Document Scope



This document is meant to serve as a hardware reference and installation guide for KAYA's second-generation frame grabbers: the Predator II CoaXPress, Komodo II CoaXPress, Komodo II CLHS and Chameleon II.

The guide consists of 8 chapters split into two main parts: the first (chapters 5 through 11) refers to the hardware of the cards and includes an overview and interface layouts, PCIe working modes, LED states, GPIO connectors and pinout, mechanical drawings, environmental conditions and electrical specifications. The second part refers to the installation and set-up process for each of the cards.

Please feel free to contact our team over at support@kayainstruments.com with any questions that may arise.

4 Card Overview

4.1 Predator II CoaXPress Connectors and LEDs Layout

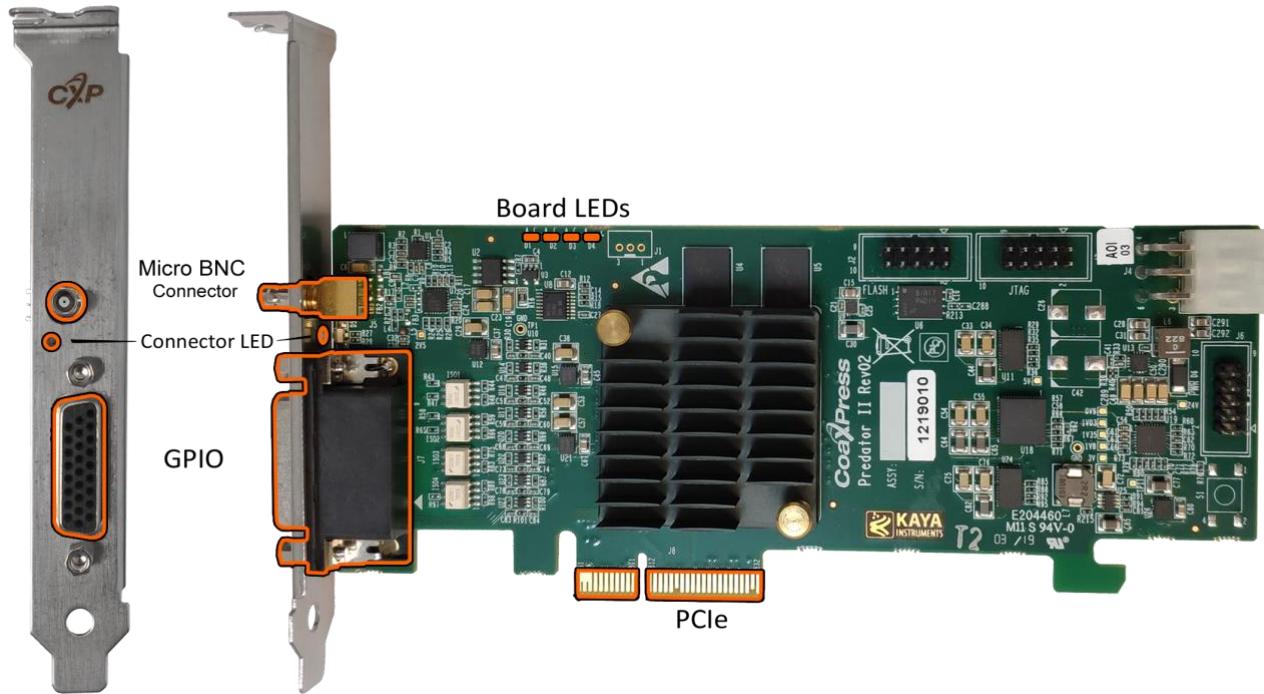


Figure 1 – Predator II connector topology

4.2 Chameleon II Connectors and LEDs Layout

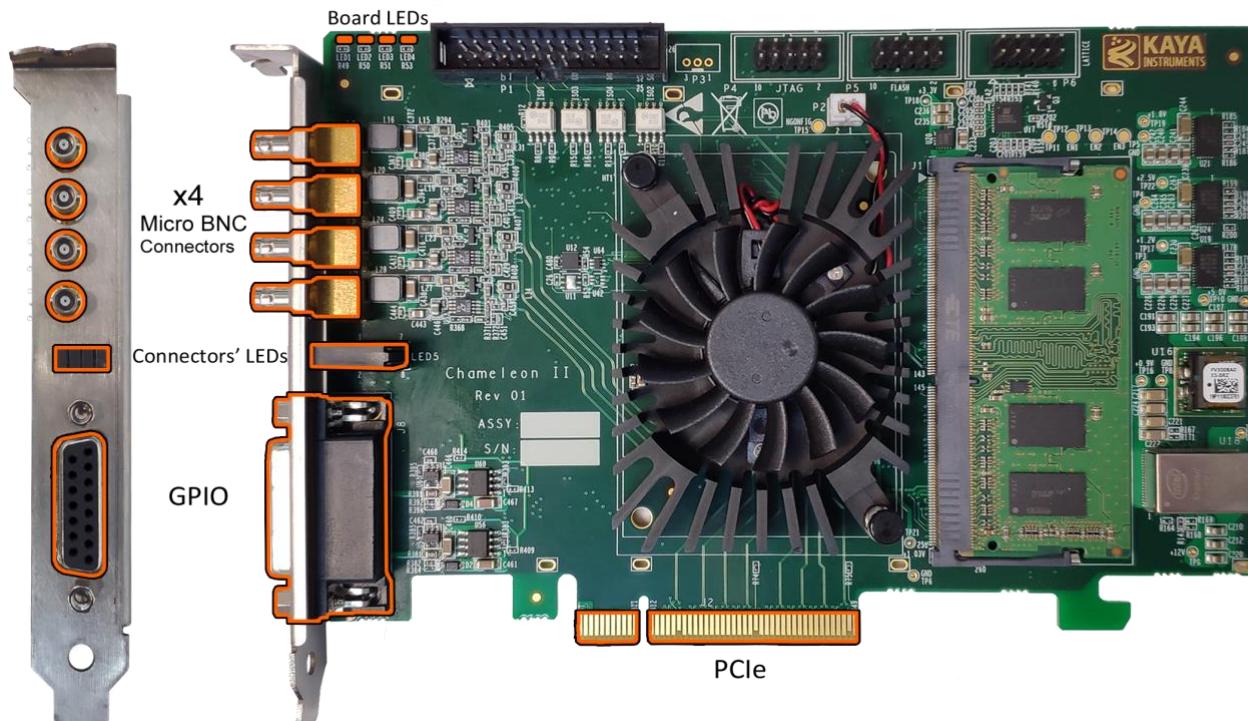


Figure 2 – Chameleon II connector topology

4.3 Komodo II CoaXPress Connectors and LEDs Layout

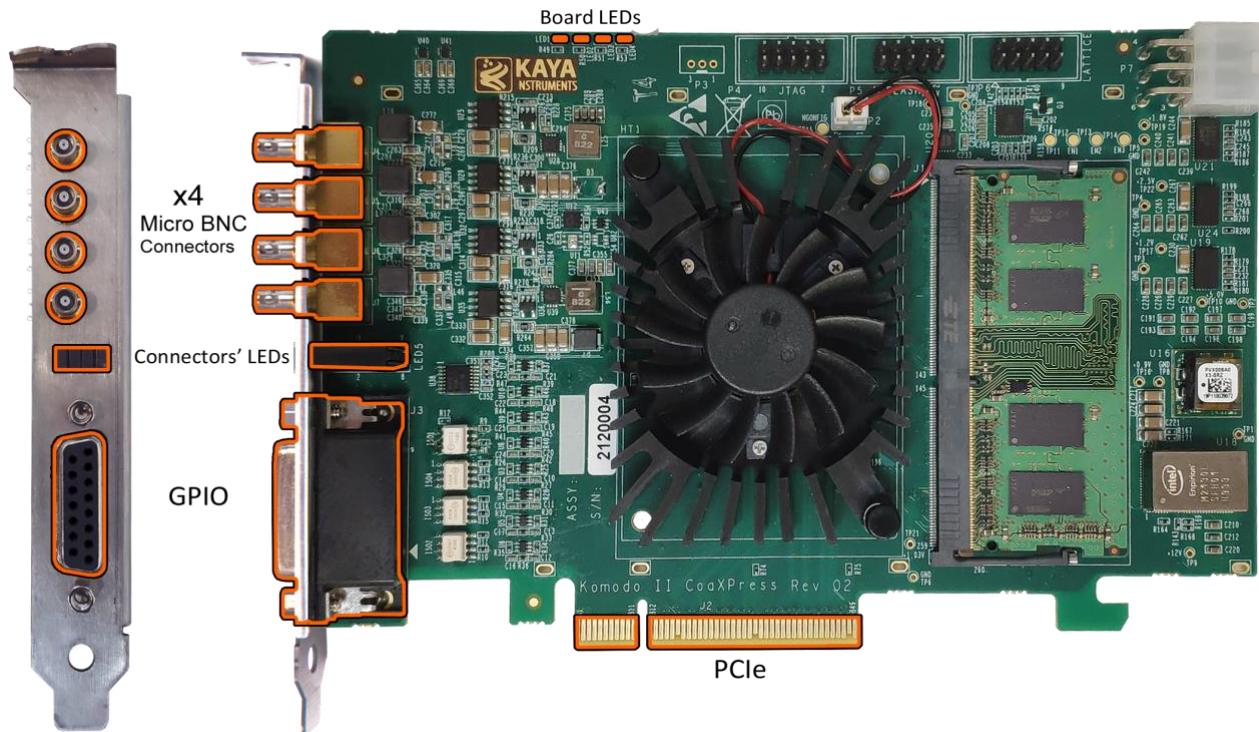


Figure 3 – Komodo II CoaXPress connector topology

4.4 Komodo II CLHS Connectors and LEDs Layout

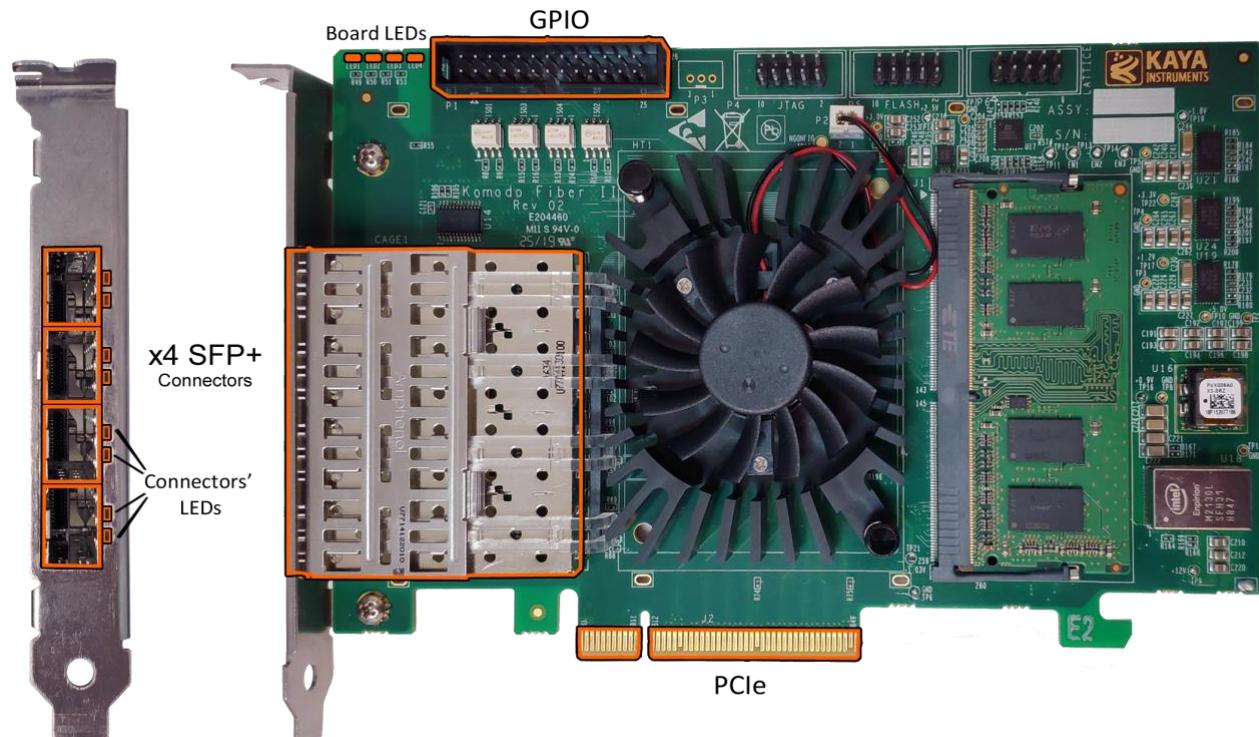


Figure 4 – Komodo II CLHS connector topology

5 PCIe Working Modes

The newest PCIe generations supported and maximal bandwidth for each card are listed in the following table:

| Card | Newest Supported PCIe Generation | Maximal Bandwidth (Newest PCIe Generation) |
|------------------------|----------------------------------|--|
| Predator II CoaXPress | Gen 2.4, up to 4 lanes | 12 [Gbps] |
| Chameleon II CoaXPress | Gen 3, up to 8 lanes | 40 [Gbps] |
| Komodo II CoaXPress | Gen 3, up to 8 lanes | 55 [Gbps] |
| Komodo II CLHS | Gen 3, up to 8 lanes | 55 [Gbps] |

Table 2 – PCIe working modes

6 Card LEDs

6.1.1 Connector LEDs

The bi-color LEDs behave according to the definition in section 5.4 of the CoaXPress standard. Color-coded indications along with the exact timing for each indicator are shown in the following tables:

| LED state | Indication |
|-------------------------------------|---|
| (Solid green) | The camera is connected, and no data is being transferred |
| (Fast flash green) | The camera is connected, and data is being transferred |
| (Fast flash alternate green/orange) | Connection detection in progress, PoCXP active |
| (Slow flash alternate green/orange) | Connection test packets being sent |
| (Solid orange) | The system is not initialized |
| (Slow pulse orange) | Camera connected. Waiting for the trigger event |
| (Fast flash orange) | Connection detection in progress, PoCXP not in use |
| (Slow pulse red) | No camera is connected |
| (Solid red) | PoCXP over-current |

Table 3 – Connector indicator lamp states

| Indication | Timing |
|--------------|----------------------------|
| (Fast flash) | 12.5Hz (20ms on, 60ms off) |
| (Slow flash) | 0.5Hz (1s on, 1s off) |
| (Slow pulse) | 1Hz (200ms on, 800ms off) |

Table 4 – Connector indication lamp timings

6.1.2 Board Status LEDs

| LED | Description |
|-----|---|
| 0 | Alive led. Blinks when the board receives clock from PCIe |
| 1 | PCIe LO state. When lit, indicates that the PCIe interface is powered up at an active state. |
| 2 | Maximum supported PCIe gen indicator. When lit indicates that PCIe is working as Gen3 (2.4 for the Predator II CoaXPress) When not lit the board works either as PCIe Gen1 or Gen2 (or just PCIe Gen1 for the Predator II CoaXPress). |
| 3 | Lane's indicator. When lit, indicates that all PCIe lanes are up. If not lit, one of four lanes is up (only one for the Predator II CoaXPress). |

Table 5 – Status indicator lamp states

7 CoaXPress Cables

CoaXPress is a new digital transmission standard that allows high-speed data from a device, such as a camera, to be transferred to a host, such as a frame grabber. Each CoaXPress link supports up to 12.5 Gbps data rates, along with device power up to 13W and device control at up to 30 Mbps – all on a single coax cable. For very fast devices, the links can be aggregated to provide multiples of the single coax bandwidth. Long cable lengths are supported – up to 30 meters at 12.5Gbps and over 100 meters at 3.125 Gbps.

Table 6 gives an overview of typical link performance at room temperature for the link between two FMX II CoaXPress boards, using the downlink channel, uplink channel and power transmission simultaneously.



| BELDEN | Name | Belden 7731A | Belden 1694A | Belden 1505A | Belden 1505F | Belden 1855A |
|------------|------|---------------|-------------------|--------------|--------------|----------------|
| | Type | Long Distance | Industry Standard | Compromise | Flexible | Thinnest cable |
| Diameter | (mm) | 10.3 | 6.99 | 5.94 | 6.15 | 4.03 |
| 1.25 Gbps | (m) | 194 | 130 | 107 | 80 | 55 |
| 2.5 Gbps | (m) | 162 | 110 | 94 | 66 | 55 |
| 3.125 Gbps | (m) | 147 | 100 | 86 | 60 | 55 |
| 5.0 Gbps | (m) | 87 | 60 | 52 | 35 | 38 |
| 6.25 Gbps | (m) | 58 | 40 | 35 | 23 | 25 |
| 10 Gbps | (m) | TBD | 40 | TBD | TBD | TBD |
| 12 Gbps | (m) | TBD | 30 | TBD | TBD | TBD |
| Length | | | | | | |

| GEPCO | Name | Gepco VHD1100 | Gepco VSD2001 | Gepco VPM2000 | Gepco VHD2000M | Gepco VDM230 |
|------------|------|---------------|-------------------|-----------------|----------------|----------------|
| | Type | Long Distance | Industry Standard | Compromise Coax | Flexible | Thinnest cable |
| Diameter | (mm) | 10.3 | 6.91 | 6.15 | 6.15 | 4.16 |
| 1.25 Gbps | (m) | 212 | 140 | 109 | 81 | 66 |
| 2.5 Gbps | (m) | 185 | 120 | 94 | 67 | 66 |
| 3.125 Gbps | (m) | 169 | 110 | 86 | 61 | 62 |
| 5.0 Gbps | (m) | 102 | 66 | 53 | 36 | 38 |
| 6.25 Gbps | (m) | 68 | 44 | 35 | 24 | 25 |
| 10 Gbps | (m) | TBD | TBD | TBD | TBD | TBD |
| 12 Gbps | (m) | TBD | TBD | TBD | TBD | TBD |
| Length | | | | | | |

Table 6 – Typical link performance

8 General Purpose Input Output

8.1 GPIO Connectors

Our second-generation cards come with one of two possible GPIO connectors: the 26-pin, 3-row D-Sub connector accessible from the front bracket (Komodo II CoaXPress and Predator I CoaXPress) and the 26-pin, dual row pin header connector that is located on the PCB itself (Komodo II CLHS and Chameleon II CoaXPress).

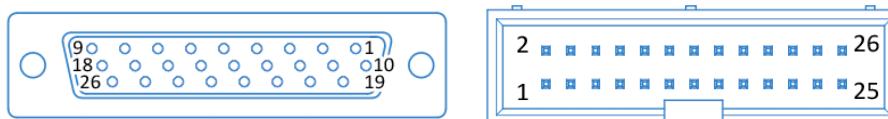


Figure 5 – GPIO connector schematics
3-row D-Sub connector (left) and dual row pin header (right)

| Connector | Manufacturer's Part Number |
|-----------------------------|----------------------------|
| 26-pin, 3-row D-Sub | 181-026-213R561 |
| 26-pin, dual row pin header | CH87262V200 |

Table 7 – GPIO connectors part numbers

8.2 GPIO Pinout

The pinout for each of these connectors is as described:

| Pin | Signal Name | Function | Electrical | Description |
|-----|----------------------|----------------------|------------------|--|
| 1 | LVDS Input 0p | LVDS input | LVDS | Positive signal of LVDS pair |
| 2 | LVDS Input 0n | LVDS input | LVDS | Negative signal of LVDS pair |
| 3 | LVDS Input 1p | LVDS input | LVDS | Positive signal of LVDS pair |
| 4 | LVDS Input 1n | LVDS input | LVDS | Negative signal of LVDS pair |
| 5 | LVDS Output 0p | LVDS output | LVDS | Positive signal of LVDS pair |
| 6 | LVDS Output 0n | LVDS output | LVDS | Negative signal of LVDS pair |
| 7 | LVDS Output 1p | LVDS output | LVDS | Positive signal of LVDS pair |
| 8 | LVDS Output 1n | LVDS output | LVDS | Negative signal of LVDS pair |
| 9 | Optocoupled Output 0 | Opto-Isolated output | Up to 70V | Optically isolated outputs |
| 10 | Optocoupled Output 1 | Opto-Isolated output | Up to 70V | Optically isolated outputs |
| 11 | Optocoupled Output 2 | Opto-Isolated output | Up to 70V | Optically isolated outputs |
| 12 | Optocoupled Output 3 | Opto-Isolated output | Up to 70V | Optically isolated outputs |
| 13 | Optocoupled Input 0 | Opto-Isolated input | Up to 70V | Optically isolated inputs |
| 14 | Optocoupled Input 1 | Opto-Isolated input | Up to 70V | Optically isolated inputs |
| 15 | Optocoupled Input 2 | Opto-Isolated input | Up to 70V | Optically isolated inputs |
| 16 | Optocoupled Input 3 | Opto-Isolated input | Up to 70V | Optically isolated inputs |
| 17 | Optocoupled GND | External GND | | Ground signal for optoisolated signals on this connector |
| 18 | GND | Board GND | | Reference ground signal |
| 19 | TTL 0 | GPIO | TTL (Open-drain) | General Purpose IO |
| 20 | TTL 1 | GPIO | TTL (Open-drain) | General Purpose IO |
| 21 | TTL 2 | GPIO | TTL (Open-drain) | General Purpose IO |
| 22 | TTL 3 | GPIO | TTL (Open-drain) | General Purpose IO |
| 23 | LVTTL 0 | GPIO | LVTTL | General Purpose IO |
| 24 | LVTTL 1 | GPIO | LVTTL | General Purpose IO |
| 25 | LVTTL 2 | GPIO | LVTTL | General Purpose IO |
| 26 | LVTTL 3 | GPIO | LVTTL | General Purpose IO |

Table 8 – GPIO connector pinout

8.3 GPIO Output / Input

8.3.1 LVDS Inputs

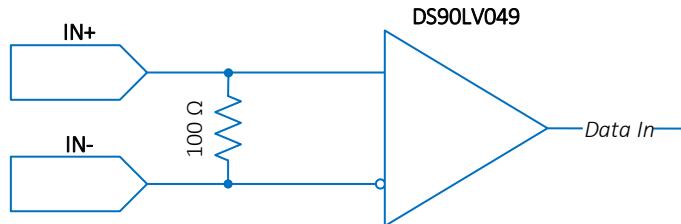


Figure 6 – LVDS inputs schematics

DC Characteristics:

| Parameter | Conditions | Min | Typical | Max | Units |
|--------------------------|--|----------|---------|-----|---------|
| Common mode voltage | | 0.05 | | 3 | V |
| Differential sensitivity | | | | 100 | mV |
| Input impedance | | | 100 | | Ohm |
| ESD protection | HBM, 1.5 kΩ, 100 pF MM, 0 Ω, 200 pF | 7 250 | | | kV V |

Table 9 – LVDS inputs DC characteristics

AC Characteristics:

| Parameter | Conditions | Min | Typical | Max | Units |
|------------------------|------------|-----|---------|-----|-------|
| Pulse width | | 50 | | | ns |
| Pulse rate | | 0 | | 5 | MHz |
| 10%-90% rise/fall time | | 0.3 | | 1.4 | ns |

Table 10 – LVDS inputs DC & AC characteristics

8.3.2 LVDS Outputs

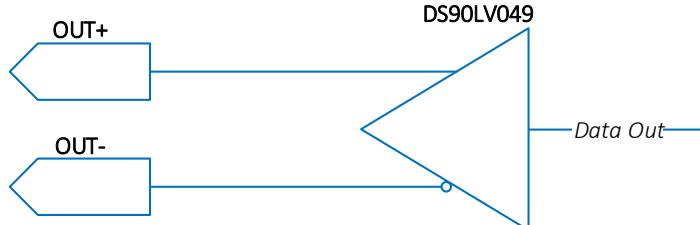


Figure 7 – LVDS outputs schematics

DC Characteristics:

| Parameter | Conditions | Min | Typ | Max | Units |
|-----------------------------|--|----------|------|-------|---------|
| Common mode voltage | | 1.125 | 1.23 | 1.375 | V |
| Differential output voltage | | 250 | 350 | 450 | mV |
| Output Short Circuit | | | -5.8 | -9 | mA |
| ESD protection | HBM, 1.5 kΩ, 100 pF MM, 0 Ω, 200 pF | 7 250 | | | kV V |

Table 11 – LVDS outputs DC characteristics

AC Characteristics:

| Parameter | Conditions | Min | Typ | Max | Units |
|------------------------|------------|-----|-----|-----|-------|
| Pulse width | | 50 | | | ns |
| Pulse rate | | 0 | | 5 | MHz |
| 10%-90% rise/fall time | | 0.2 | 0.4 | 1 | ns |

Table 12 – LVDS outputs AC characteristics

8.3.3 TTL Inputs/Outputs

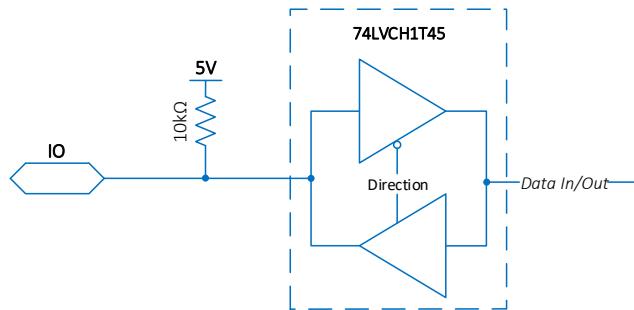


Figure 8 – TTL inputs/outputs schematics

DC Characteristics:

| Parameter | Conditions | Min | Typical | Max | Units |
|---------------------------|--------------------------------------|--------|---------|------|-------|
| Low-level output current | | | | 50 | mA |
| Low-level output voltage | IO = 32 mA | | | 0.55 | V |
| High-level output current | | | | -50 | mA |
| High-level output voltage | IO = -32 mA | 3.8 | | | V |
| Low-level input voltage | | | | 1.5 | V |
| High-level input voltage | | 3.5 | | | V |
| Absolute maximum input | | -0.5 | | 6.5 | V |
| ESD protection | HBM JESD22-A114F CDM JESD22-C101E | 4 1 | | | kV |

Table 13 – TTL inputs/outputs DC characteristics

AC Characteristics:

| Parameter | Conditions | Min | Typical | Max | Units |
|-------------|------------|-----|---------|-----|-------|
| Pulse width | | 50 | | | ns |
| Pulse rate | | 0 | | 5 | MHz |

Table 14 – TTL inputs/outputs AC characteristics

8.3.4 LVTTL Inputs/Outputs

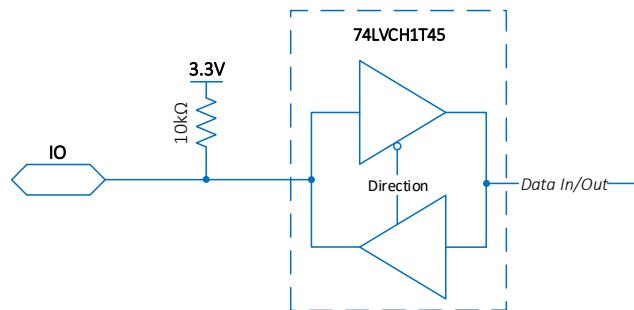


Figure 9 – LVTTL inputs/outputs schematics

DC Characteristics:

| Parameter | Conditions | Min | Typical | Max | Units |
|---------------------------|--------------------------------------|--------|---------|------|-------|
| Low-level output current | | | | 50 | mA |
| Low-level output voltage | IO = 24 mA | | | 0.55 | V |
| High-level output current | | | | -50 | mA |
| High-level output voltage | IO = -24 mA | 2.4 | | | V |
| Low-level input voltage | | | | 0.8 | V |
| High-level input voltage | | 2.3 | | | V |
| Absolute maximum input | | -0.5 | | 6.5 | V |
| ESD protection | HBM JESD22-A114F CDM JESD22-C101E | 4 1 | | | kV |

Table 15 – LVTTL inputs/outputs DC characteristics

AC Characteristics:

| Parameter | Conditions | Min | Typical | Max | Units |
|-------------|------------|-----|---------|-----|-------|
| Pulse width | | 50 | | | ns |
| Pulse rate | | 0 | | 5 | MHz |

Table 16 – LVTTL inputs/outputs AC characteristics

8.3.5 Isolated Input

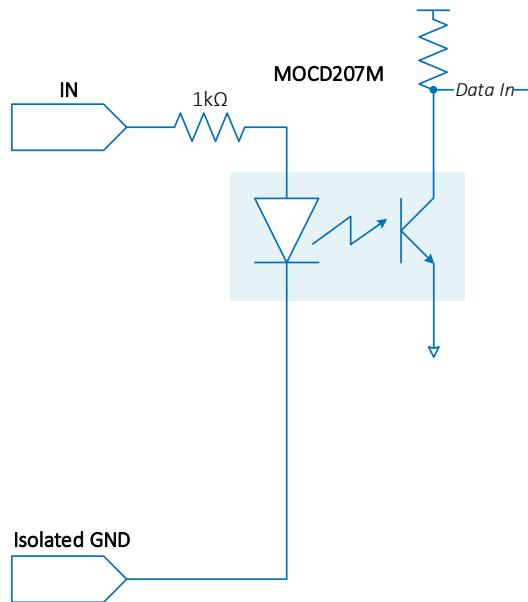


Figure 10 – Isolated input schematics

When the input current exceeds the threshold, the input logic state is HIGH.

DC Characteristics:

| Parameter | Conditions | Min | Typical | Max | Units |
|-------------------------|------------|-----|---------|-----|------------------|
| Input Voltage | | -6 | | 50 | V |
| Input current threshold | | | 3 | | mA |
| DC Isolation | | 250 | | | V |
| AC Isolation | | 150 | | | V _{RMS} |

Table 17 – Isolated input DC characteristics

AC Characteristics:

| Parameter | Conditions | Min | Typical | Max | Units |
|-------------|------------|-----|---------|-----|-------|
| Pulse width | | 10 | | | us |
| Pulse rate | | 0 | | 5 | KHz |

Table 18 – Isolated AC characteristics

8.3.6 Isolated Output

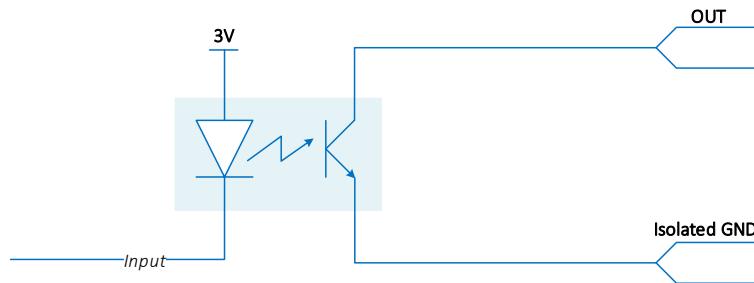


Figure 11 – Isolated output schematics

When the logic state is HIGH the output is in a conductive state (switch ON)

DC Characteristics:

| Parameter | Conditions | Min | Typical | Max | Units |
|-------------------------|------------|-----|---------|-----|------------------|
| Input Voltage | | -6 | | 50 | V |
| Input current threshold | | | 3 | | mA |
| DC Isolation | | 250 | | | V |
| AC Isolation | | 150 | | | V _{RMS} |

Table 19 – Isolated output DC characteristics

AC Characteristics:

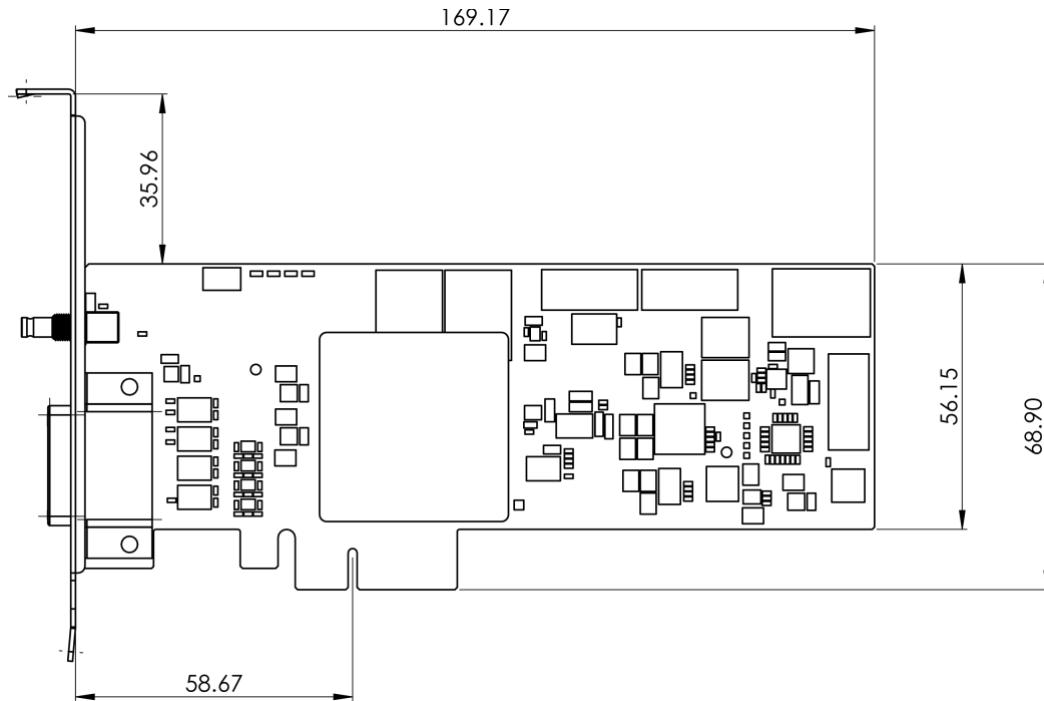
| Parameter | Conditions | Min | Typical | Max | Units |
|-------------|------------|-----|---------|-----|-------|
| Pulse width | | 10 | | | us |
| Pulse rate | | 0 | | 5 | KHz |

Table 20 – Isolated output AC characteristics

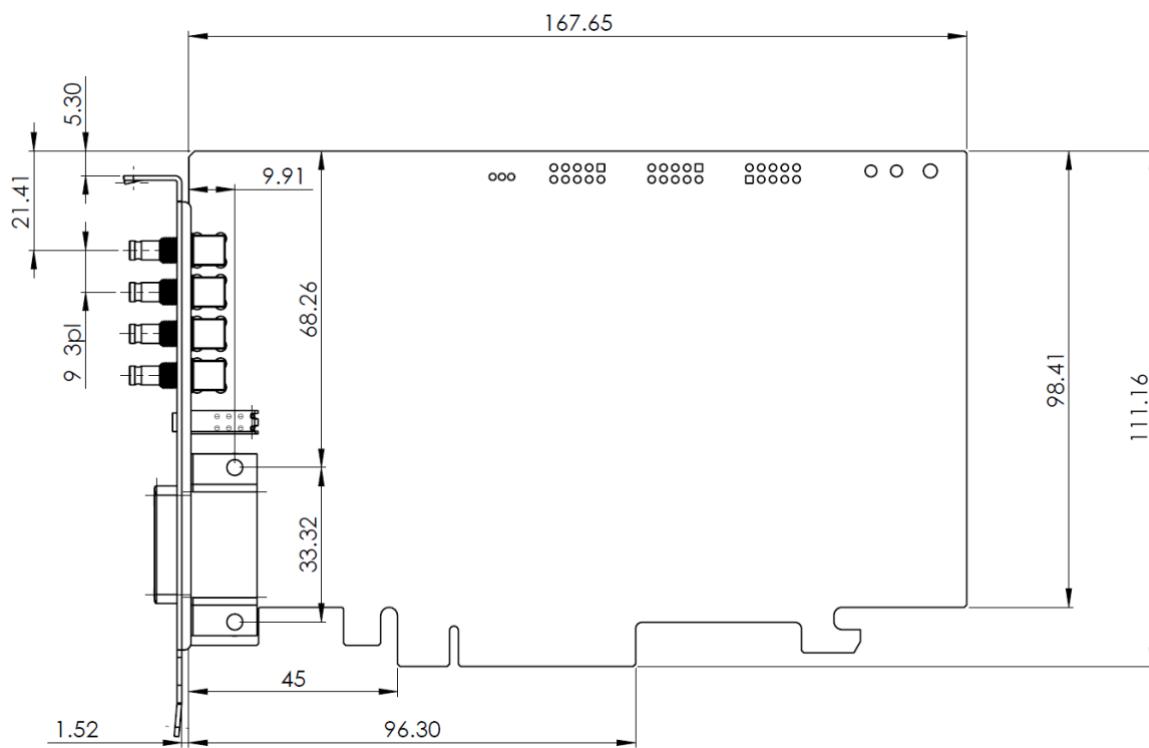
9 Mechanical Specifications

9.1 Mechanical Drawings

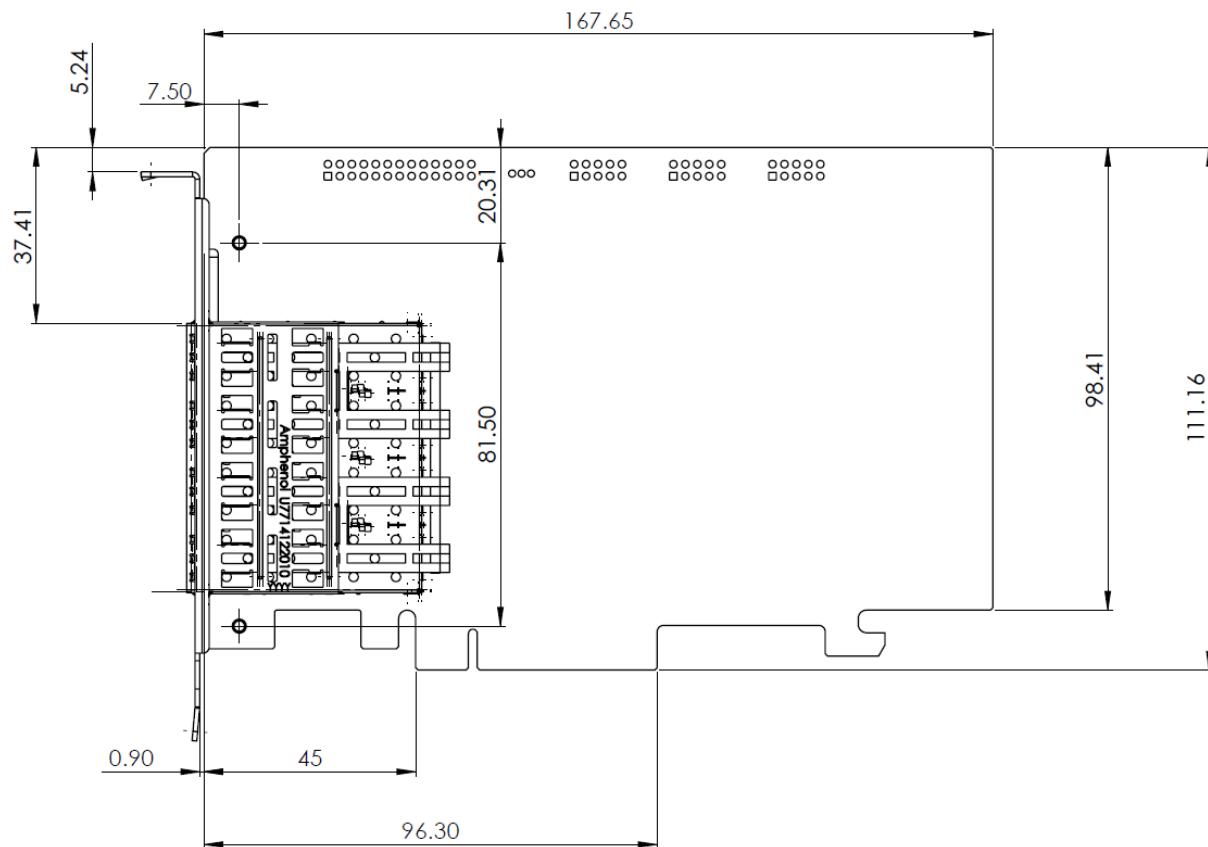
9.1.1 Predator II CoaXPress Mechanical Drawing



9.1.2 Chameleon II CoaXPress / Komodo II CoaXPress Mechanical Drawing



9.1.3 Komodo II CLHS Mechanical Drawing



9.2 Weight & Environmental Conditions

Table no. 21 lists the weight of each card:

| Card | Weight |
|------------------------|------------|
| Predator II CoaXPress | ~ 130 [gr] |
| Chameleon II CoaXPress | ~ 225 [gr] |
| Komodo II CoaXPress | ~ 225 [gr] |
| Komodo II CLHS | ~ 225 [gr] |

Table 21 – Card's weight

Storage and operating temperature are identical for all four cards:

| Specification | Value |
|-------------------------------|----------------|
| Storage temperature | -55°C to 125°C |
| Operating ambient temperature | 0°C to 50°C |

Table 22 – Absolute maximum temperature ratings

10 Power Specification

10.1 Absolute Maximum Ratings

| Specification | Values |
|-------------------|----------------|
| 3.3V power supply | -0.3V to +3.7V |
| 12V power supply | -0.3V to 14V |

Table 23 – Absolute maximum electrical ratings

| Card | Minimum voltage [V] | Maximum voltage [V] |
|---------------------|---------------------|---------------------|
| LVDS | -0.3 | 3.6 |
| Opto-isolated (in) | -6.0 | 60 |
| Opto-isolated (out) | -7.0 | 70 |
| TTL | -0.5 | 6.5 |
| LVTTL | -0.5 | 6.5 |

Table 24 – Absolute maximum ratings for GPIO

11 Installation & Configuration

11.1 Installation Instructions

Our cards can be installed onto any PCIe connector of the supported PCIe standard (See Table 2 – PCIe working modes)– PCIe working modes. It is important to note that your card should be installed **before** you install your software.

Installation steps are as follows:

1. Before installing, turn off the power of the computer and its peripherals.
2. Use an ESD-preventive glove, wrist or ankle strap and follow its instructions for use.
3. Make sure there is no dust or any other foreign matter inside the PCIe slot and the Frame Grabbers PCIe connector, or blocking any of the connectors
4. Firmly insert the card into the PCIe connector of the motherboard.
5. Anchor the PCIe bracket to the computer chassis using an M3 screw.
6. Verify the card is inserted correctly into the PCIe slot.
7. Connect the external power supply to a dedicated connector (Komodo II CoaXPress and Predator II CoaXPress).
8. Power on the computer.
9. After OS is up, you will be asked to install a driver for the new Multimedia Device.

At this stage, you should Cancel the installation.

The compatible drivers for your card will be installed during the installation of our Vision Point software (Windows and Linux only). Multiple cards can be installed and used on a single computer – the exact number depends on the number of available PCIe slots.

NOTE: Inserting and/or removing KAYA PCI devices requires a reboot of the computer or restart of the "KAYA Instruments" service. After that, one may use Vision Point software or open API examples with KAYA devices.

11.2 CoaXPress Cards

Our CoaXPress cards (**Komodo II CoaXPress**, **Chameleon II CoaXPress** and **Predator II CoaXPress**) implement CoaXPress standard Micro-BNC connectors for CoaXPress interfaces. When attaching cables to your card you must use 75Ω coaxial cables. For best performance, it's recommended to use high-quality cables, such as Belden 1694A and Belden 4855A.

If you are using more than a single cable to connect to the same card, the cables you use must be of the same type and length.

11.2.1 Installing and Removing Micro-BNC Cables

Connecting a Micro-BNC cable is simple and straightforward. First, notice a pin on the male connector. An "L" shaped channel is cut out from the female connector. When connecting the cable push the connector onto the male-end, making sure the pin and channel align. There should be no need to apply much pressure and it is advised to avoid doing to prevent unnecessary damage to the cable or the card.

Figure no. 12 illustrates the process:

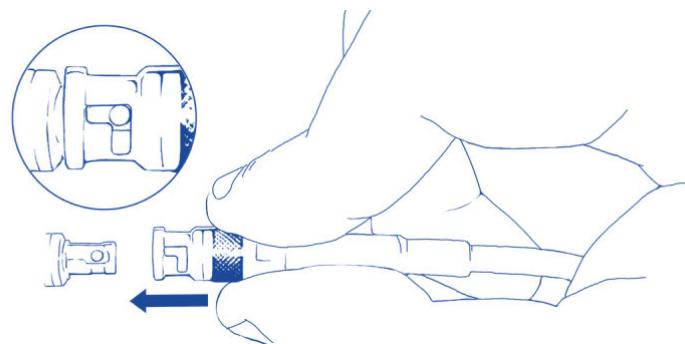


Figure 12 – Pushing the Micro-BNC connector into place

Once pushed all the way through, twist the connector clockwise. The pin will move in the channel locking the connector in position:

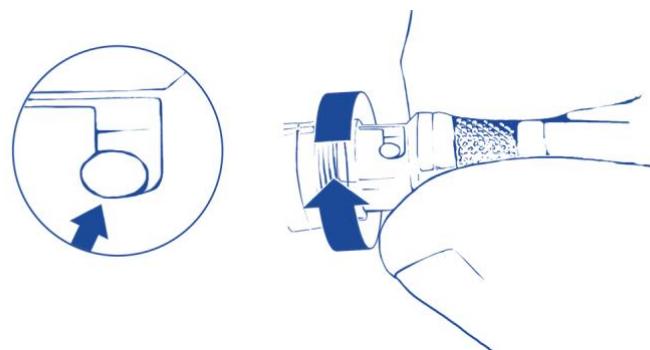


Figure 13 – Twisting the connector and securing it in position

To remove the cable, repeat the process from finish to start: twist the connector counter-clockwise and pull it out.
Do not force the cable out! If you feel resistance check for the pin location in the channel. Adjust as needed and only then pull the cable out.

11.3 CLHS Cards

11.3.1 Installing & Removing SFP+ Modules

The purpose of this section is to demonstrate how to install an SFP+ transceiver module, attach an optical network cable and remove an SFP+ transceiver module. It is necessary to understand the correct way of installing and removing an SFP+ transceiver, as correct operation can protect the module from being damaged and ensure its stable performance. Before removing or installing an SFP+ module, please follow the precautions and installation instructions.

11.3.2 Precautions

1. Use an ESD-preventive wrist or ankle strap and follow its instructions for use.
2. Make sure there is no dust or any other foreign matter inside the SFP+ module, or blocking any of the connectors.
3. Clean the optic surfaces of the fiber cables before plugging them into the optical ports of an SFP+ module.
4. Removing and inserting a module can shorten its useful life, so you should not remove and insert the module any more often than is necessary.
5. Insert the clean dust covers into the module after the cables are removed. Do not remove the dust plug until you are ready to attach the network interface cable.
6. Do not install or remove the SFP+ module with fiber-optic cables attached to it because of the potential of damaging the cable, the cable connector, or the optical interfaces in the module.
7. Disconnect all cables before removing or installing a module.
8. Place the removed module on an antistatic mat or a static shielding bag if you plan to return it to the factory.
9. Protect the line card by inserting clean module cage covers into the optical module cage when there is no module installed.
10. Keep the protective dust plugs installed in the unplugged fiber-optic cable connectors and the transceiver optical bores until you are ready to make a connection.

11.3.3 Installing the SFP+ Module

To install the SFP+ module, follow these steps:

1. The Komodo II CLHS Frame Grabber supports the following SFP+ modules:
 - KY-SFP-10G31-10 – Allows up to 10km connection over single-mode fiber cable.
 - KY-SFP-10G85-3M – Allows up to 300m connection over multi-mode fiber cable.
2. Remove the dust plugs from the module as shown in figure 14 (a).
3. The SFP+ module has a bale clasp that is used to remove or install the SFP+ module.
4. Close the bale clasp before inserting the SFP+ module.
5. Line up the module with the port and slide it into the port as shown in figure 14 (b).
6. Make sure that the male connectors on the module will align with the female connectors inside the cage.
7. Verify that the modules are completely seated and secured in their assigned receptacles on the line card by firmly pushing on each module. In case the module is not completely seated and secured in the receptacle, you will hear a click as the triangular pin on the bottom of the module snaps into the hole in the receptacle.

8. Follow the exact steps to insert an additional module into the camera's fiber interface.

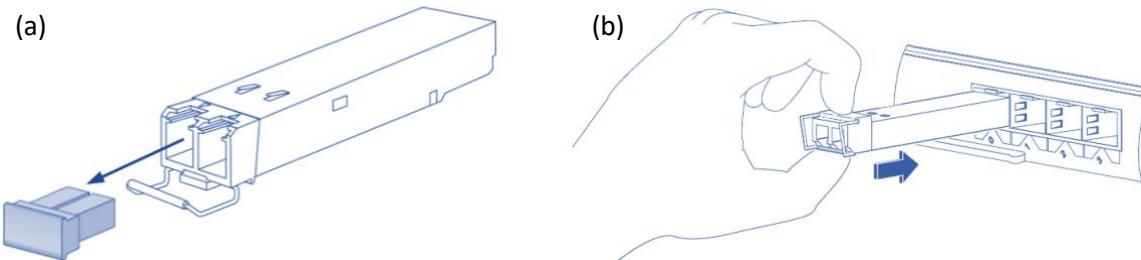


Figure 14 – SFP+ Module Installation.

(a) bale clasp open and dust plug removed, (b) Installing an SFP+ Module into a port

11.3.4 Connecting the Interface Cable to the SFP+ Module

To properly connect the fiber optic cables, the following steps must be taken:

1. Remove the protective dust plugs from the fiber-optic cable connectors.
2. Preform the connection according to the instructions below:
 - a. Link 0 of the system must be always connected as controls are delivered with this port.
 - b. A Fiber connection must be done to the same port number all over the way from the camera to the Frame Grabber.
 - c. A fiber cable should match an SFP+ type. If a single-mode SFP+ is used a single mode fiber (yellow) should be attached to it. If a multi-mode SFP+ is used a multi-mode fiber (orange) should be attached.
 - d. On Fiber channel 0 both the TX and RX fiber cables must be connected. On channels 1 through 3, only one fiber cable should be connected. This cable is connected between TX output (Marked with TX or Arrow outwards the SFP+) on the camera and RX input (Marked with RX or Arrow inwards the SFP+) on the Frame Grabber, as shown in figure 15 (a).
 - e. If more than a single cable is used to connect to the same Frame Grabber, the cables must be of the same type and length.
3. Insert the fiber cable into the module, as shown in figure 15 (b).
4. Firmly push on each cable, until you will hear a click.
5. Connect the other side of the fiber cables to the camera's SFP+ module.
6. Turn the camera and the computer on and start your Vision Point software application.

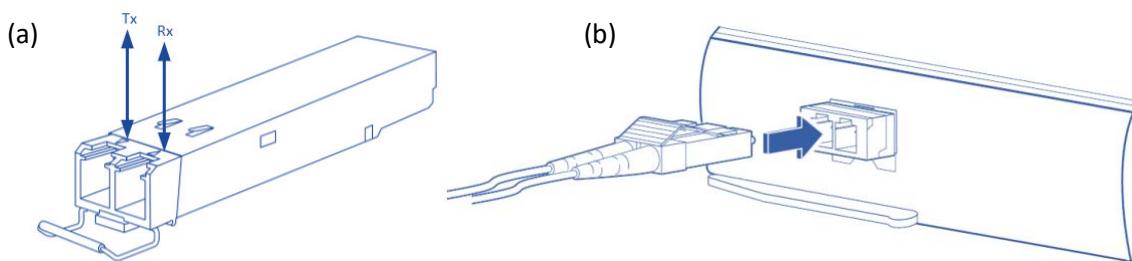


Figure 15 – Interface connecting to the SFP+ Module

(a) SFP+ module with TX output and RX input marked, b) Connecting the cable to SFP+ Module

11.3.5 Removing the SFP+ Module

1. Turn the camera and the computer off.
2. Disconnect and remove all interface cables from the ports.
3. Open the bale clasp on the SFP+ module with your index finger, or a small flat-blade screwdriver, in a downward direction, as shown in figure 15.
4. Grasp the module between your thumb and index finger and carefully remove it from the port, as shown in figure 16.
5. Insert the clean dust covers into the module, as shown in figure 17.

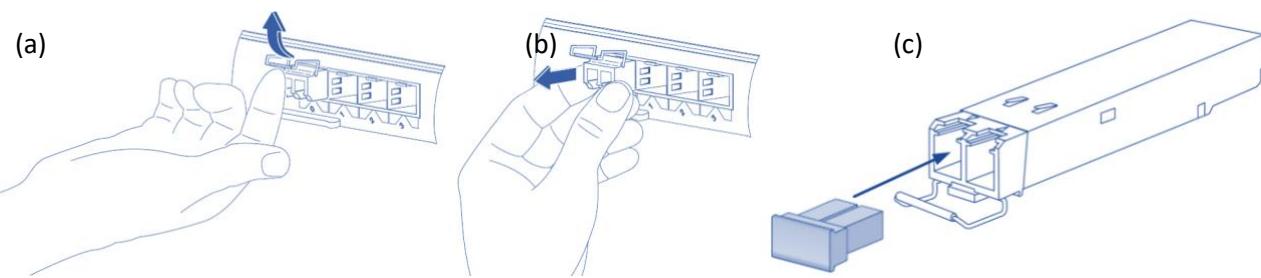


Figure 16 – Removing the SFP+ Module

(a) Opening the bale clasp of an SFP+ Module, (b) Removing an SFP+ Module from the port, (c) SFP+ Module with bale clasp open

11.4 Camera Connection Topologies

The komodo II CoaXPress, Komodo II CLHS and Chameleon II CoaXPpress frame grabbers support multiple modes of configuration and system topologies:

Single Camera Topology:

Single, dual or quad links with a maximal bandwidth of 12.5 GB/s per link (10GB/s for the CLHS). Total maximal throughput to PCIe is card-dependent, see Table 2 – PCIe working modes.

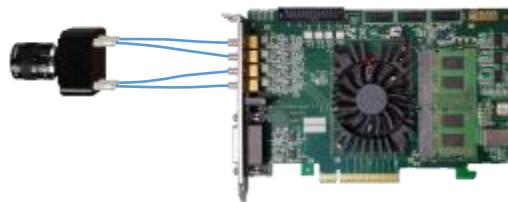


Figure 17 – Single camera topology

Dual Camera Topology:

Two single or dual links with a maximal bandwidth of 12.5 GB/s per link (10GB/s for the CLHS). Total maximal throughput to PCIe is card-dependent, see Table 2 – PCIe working modes.

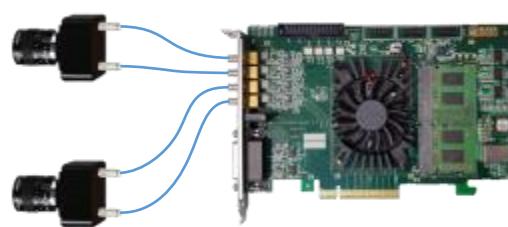


Figure 18 – Dual camera topology

Quad Camera Topology:

Four single links with a maximal bandwidth of 12.5 GB/s per link (10GB/s for the CLHS). Total maximal throughput to PCIe is card-dependent, see Table 2 – PCIe working modes.

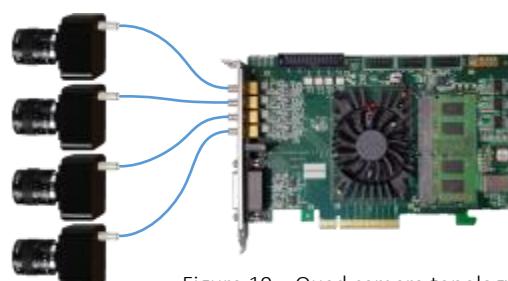


Figure 19 – Quad camera topology